

N-Channel Super Junction Power MOSFET III

General Description

The series of devices use advanced trench gate super junction technology and design to provide excellent R_{DS(ON)} with low gate charge. This super junction MOSFET fits the industry's AC-DC SMPS requirements for PFC, AC/DC power conversion, and industrial power applications.

Features

- •New technology for high voltage device
- •Low on-resistance and low conduction losses
- Small package
- ●Ultra Low Gate Charge cause lower driving requirements
- 100% Avalanche Tested
- ●ROHS compliant

Application

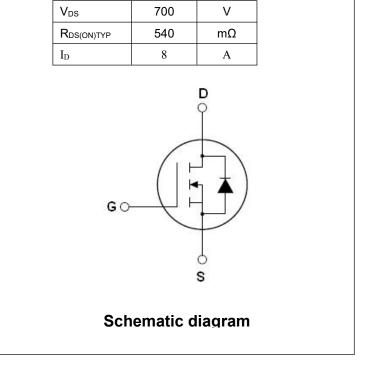
- Power factor correction (PFC)
- Switched mode power supplies(SMPS)
- Uninterruptible Power Supply (UPS)

Package Marking And Ordering Information

Device	Device Package	Marking
NCE70T540I	TO-251	NCE70T540I
NCE70T540K	TO-252	NCE70T540K

Table 1. Absolute Maximum Ratings (Tc=25℃)

Parameter	Symbol	Value	Unit	
Drain-Source Voltage (VGs=0V)	Vds	700	V	
Gate-Source Voltage (V _{DS=0} V) ,AC (f>1 Hz)	Vgs	±30	V	
Continuous Drain Current at Tc=25°C	I _{D (DC)}	8	Α	
Continuous Drain Current at Tc=100°C	I _{D (DC)}	5.2	Α	
Pulsed drain current (Note 1)	DM (pluse)	32	A	
Maximum Power Dissipation(Tc=25°C)	PD	69	W	
Derate above 25°C		0.55	W/°C	
Single pulse avalanche energy (Note2)	Eas	156	mJ	
Avalanche current ^(Note 1)	I _{AR}	1.7	Α	
Repetitive Avalanche energy , t_{AR} limited by T_{jmax} (Note 1)	E _{AR}	0.3	mJ	
Parameter	Symbol	Value	Unit	





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Drain Source voltage slope, $V_{DS} \leq 480 V$,	dv/dt	50	V/ns
Reverse diode dv/dt, $V_{DS} \leq 480 \text{ V},I_{SD} < I_D$	dv/dt	15	V/ns
Operating Junction and Storage Temperature Range	TJ,TSTG	-55+150	°C

Table 2. Thermal Characteristic

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case (Maximum)	RthJC	1.81	°C /W
Thermal Resistance, Junction-to-Ambient (Maximum)	R _{thJA}	62	°C /W

Table 3. Electrical Characteristics (TA=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
On/off states						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	700			V
Zero Gate Voltage Drain Current(Tc=25°C)	I _{DSS}	V _{DS} =700V,V _{GS} =0V			1	μA
Zero Gate Voltage Drain Current(Tc=125°C)	I _{DSS}	V _{DS} =700V,V _{GS} =0V			100	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V			±100	nA
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =250µA	3		4	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =4A		540	600	mΩ
Dynamic Characteristics		1	•			<u> </u>
Input Capacitance	Clss			590		pF
Output Capacitance	Coss	V_{DS} =50V, V_{GS} =0V,		37		pF
Reverse Transfer Capacitance	Crss	F=1.0MHz		0.9		pF
Total Gate Charge	Qg	N/ 400X/1 0A		14.6	22	nC
Gate-Source Charge	Qgs	V _{DS} =480V,I _D =8A, V _{GS} =10V		4		nC
Gate-Drain Charge	Q _{gd}	VGS=10V		6.7		nC
Switching times						
Turn-on Delay Time	t _{d(on)}			9		nS
Turn-on Rise Time	tr	V _{DD} =420V,I _D =4A,		6.5		nS
Turn-Off Delay Time	t _{d(off)}	R _G =4.7Ω,V _{GS} =10V		61		nS
Turn-Off Fall Time	t _f			10		nS
Source- Drain Diode Characteristics						
Source-drain current(Body Diode)	I _{SD}	T 05%0			8	A
Pulsed Source-drain current(Body Diode)	I _{SDM}	T _C =25°C			32	Α
Forward On Voltage	V _{SD}	Tj=25°C,I _{SD} =8A,V _{GS} =0V		0.9	1.2	V
Reverse Recovery Time	t _{rr}			230		nS
Reverse Recovery Charge	Qrr	Tj=25°C,I⊧=4A,di/dt=100A/µs		1.2		uC
Peak Reverse Recovery Current	Irrm			10.5		Α

Notes: 1.Repetitive Rating: Pulse width limited by maximum junction temperature

2. Tj=25℃,VDD=50V,VG=10V, R_G=25Ω



TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (curves)

Figure1. Safe operating area

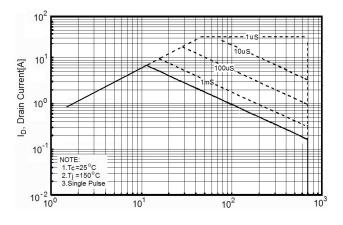


Figure3. Source-Drain Diode Forward Voltage

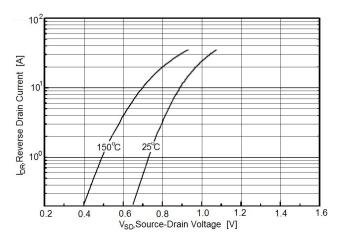


Figure 5. Transfer characteristics

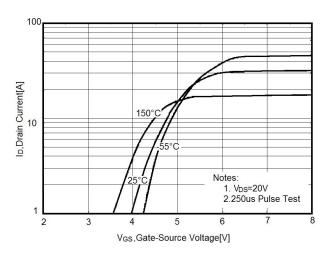




Figure2. Transient Thermal Impedance

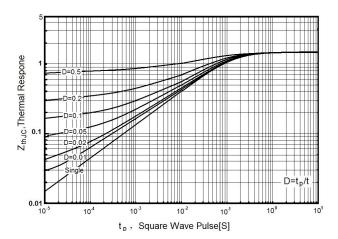


Figure4. Output characteristics

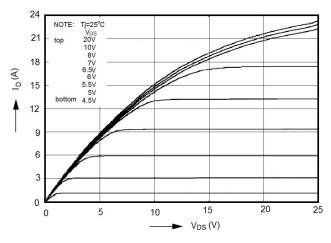


Figure6. Static drain-source on resistance

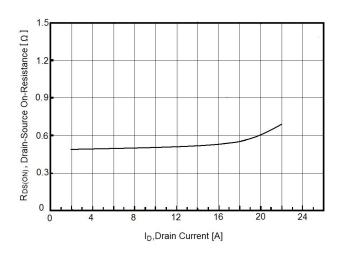
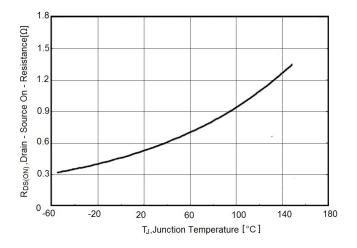


Figure8. BV_{DSS} vs Junction Temperature





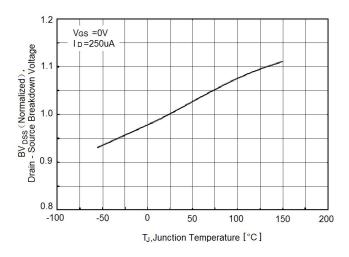


Figure9. Maximum I_D vs Junction Temperature

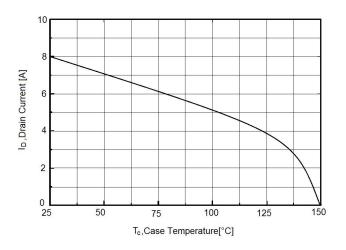


Figure11. Gate charge waveforms

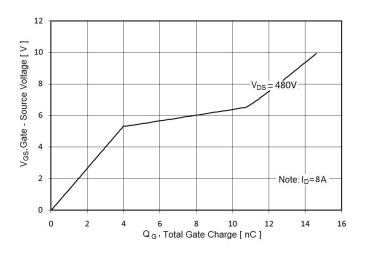
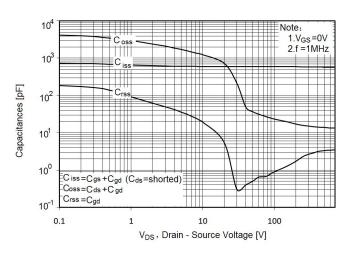


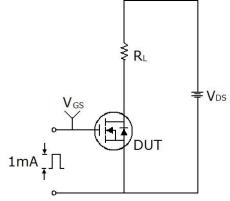
Figure10. Capacitance

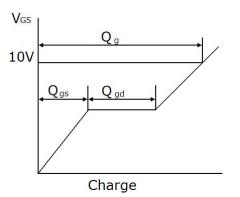




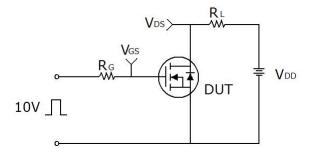
Test circuit

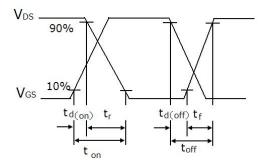
1) Gate charge test circuit & Waveform



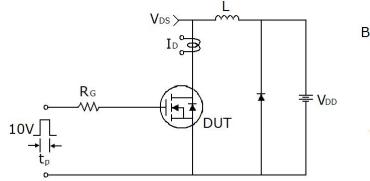


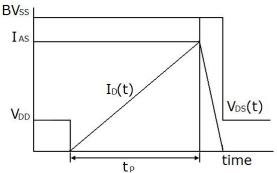
2) Switch Time Test Circuit:





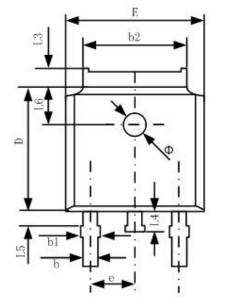
3) Unclamped Inductive Switching Test Circuit & Waveforms

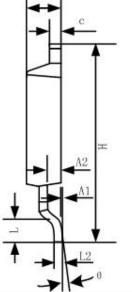


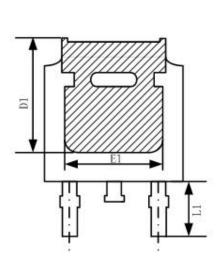




TO-252-2 Package Information



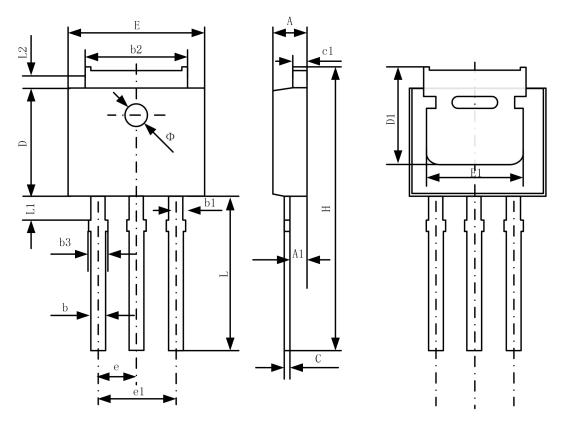




Symbol	Dimensions In Millimeters		Dimensions In Inches	
Symbol	Min.	Max.	Min.	Max.
А	2.20	2.38	0.087	0.094
A1	0.00	0.10	0.000	0.004
A2	0.90	1.10	0.035	0.043
b	0.72	0.85	0.028	0.033
b1	0.72	0.90	0.028	0.035
b2	5.13	5.46	0.202	0.215
с	0.47	0.60	0.019	0.024
D	6.00	6.20	0.236	0.244
D1	5.25		0.207	
E	6.50	6.70	0.256	0.264
E1	4.70		0.185	
e	2.19	2.39	0.086	0.094
Н	9.80	10.40	0.386	0.409
L	1.40	1.70	0.055	0.067
L1	2.90 REF		0.114	REF
L2	0.508 BSC		0.020) BSC
L3	0.90	1.25	0.035	0.049
L4	0.60	1.00	0.024	0.039
L5	0.15	0.75	0.006	0.030
L6	1.8	30 REF	0.071	I REF
Φ	1.20	1.40	0.047	0.055
θ	0°	8°	0°	8°

TO-251 Package Information





Or mark all	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
A	2.20	2.35	0.087	0.093	
A1	0.90	1.10	0.035	0.043	
b	0.56	0.69	0.022	0.027	
b1	0.77	0.90	0.030	0.035	
b2	5.23	5.43	0.206	0.214	
b3		1.05	0.000	0.041	
С	0.46	0.59	0.018	0.023	
c1	0.46	0.59	0.018	0.023	
D	6.00	6.20	0.236	0.244	
D1	5.20		0.205		
E	6.50	6.70	0.256	0.264	
E1	4.60	5.00	0.181		
e	2.24	2.34	0.088	0.092	
e1	4.47	4.67	0.176	0.184	
Н	16.18	16.78	0.637	0.661	
L	9.00	9.60	0.354	0.378	
L1	0.95	1.35	0.037	0.053	
L2	0.90	1.25	0.035	0.049	

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